

L272

Dual Power Operational Amplifier

Features

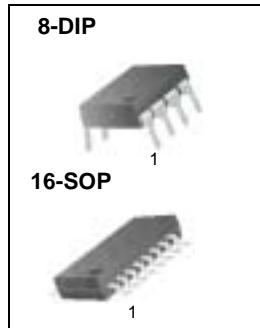
- Output Current upto 0.7A
- Operates at Low Voltage ($V_S(MIN)=4V$)
- Low Saturation Voltage ($I_p=0.5A$, $V_O=1.5V$)
- Thermal Shutdown ($TSD=160^{\circ}C$)
- Ground Compatible Inputs
- Large Common mode & Differential mode Range

Applications

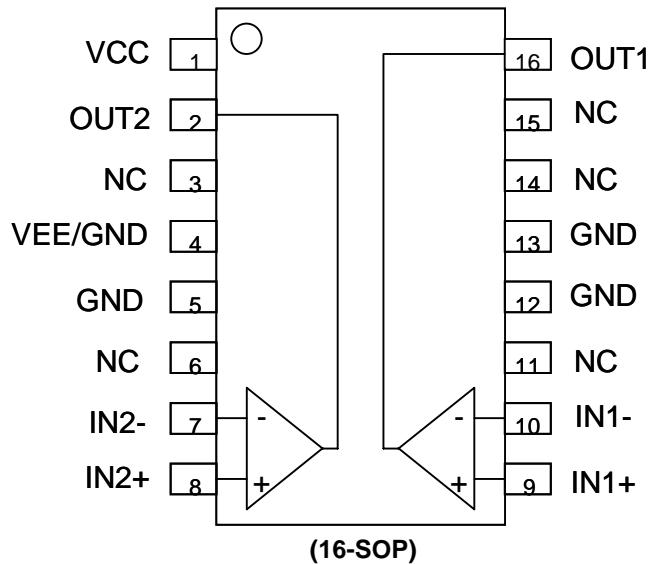
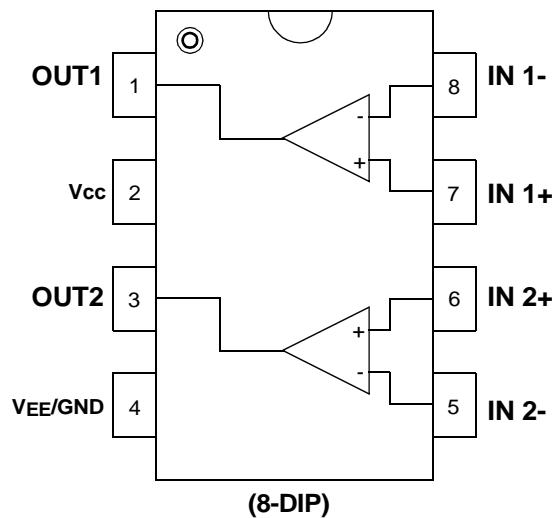
- Servo Amplifier
- Power Supply
- Compact Disc
- VCR
- Monitor

Description

The L272 is a high-power dual operational amplifier provided as a 8-DIP and 16-SOP package. The operational amplifier is designed for low impedance loads and will deliver output current upto 0.7A. The L272 can be used in a wide range of applications including power supply, VCR, monitor, servo amplifier, compact disc, etc



Internal Block Diagram



PIN Definitions

Pin Number		Pin Name	Pin Function Description
8-DIP	16-SOP		
1	16	OUTPUT1	Amp Output 1
2	1	VCC	Positive Supply Voltage
3	2	OUTPUT2	Amp Output 2
4	4/5/12/13	VEE/GND	Negative Supply Voltage (GND)
5	7	INPUT-2	Amp Negative Input 2
6	8	INPUT+2	Amp Positive Input 2
7	9	INPUT+1	Amp Positive Input 1
8	10	INPUT-1	Amp Negative Input 1

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Supply Voltage	VCC	40	V
Input Voltage	VI	VS	V
Differential Input Voltage	VI(DIFF)	±VS	V
DC Output Current	IO	0.7	A
Peak Output Current (non repetitive)	IP	1	A
Power dissipation at: Tamb=50°C	Ptot	1	W
Operating Temperature Range	Top	-25 to 85	°C
Storage and Junction Temperature	Tstg, Tj	-40 to 150	°C

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-Ambient Max. 8-DIP 16-SOP	Rθja	100 190	°C/W

Electrical Characteristics

(Vcc = +12V, VEE = -12V, Ta = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply Voltage (VCC - VEE)	V _S		4	-	28	V
Supply Current	I _S	V _O = VCC/2 VCC=24V, VEE=0V VCC=12V, VEE=0V	-	8 7.5	12 11	mA mA
Input Bias Current	I _{BIAS}	-	-	0.3	2.5	μA
Input Offset Voltage	V _{IO}	-	-	15	60	mV
Input Offset Current	I _{IO}	-	-	50	250	nA
Slew Rate	SR	V _{in} = 1Vpp, Unit Gain	-	1	-	V/μs
Gain-Bandwidth Product	GBW	-	-	350	-	KHz
Input Resistance	R _I	-	500	-	-	KΩ
Lange Signal	G _V	V _{O(pp)} = ±10V	65	75	-	dB
Input Noise Voltage	e _N	B = 20KHz	-	10	-	μV
Input Noise Current	I _N	B = 20KHz	-	200	-	pA
Common Mode Rejection Ratio	CMRR	-	60	75	-	dB
Supply Voltage Rejection Ratio	PSRR	V _{CC} = +15V, V _{EE} = -15V V _{CC} = +5V, V _{EE} = -5V	54	62	-	dB
Output Voltage Swing	V _O	V _{CC} = 24V, V _{EE} = 0V I _p = 0.1A I _p = 0.5A	21 21	23 22.5	-	V V
Channel Separation	C _S	f = 1kHz; R _L = 10Ω, G _V = 30dB	-	60	-	dB
Total Harmonic Distortion	THD	f = 1kHz, G _V = 1dB, R _L = ∞	-	0.5	-	%
Thermal shutdown Temperature (Note1)	TSD	-	-	160	-	°C

Note :

- Guaranteed by design. Not 100% tested in production.

Typical Performance Characteristics

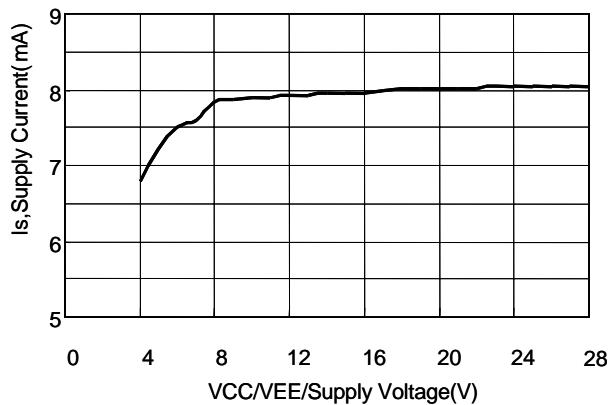


Figure 1. Supply Voltage vs Supply Current with No Load

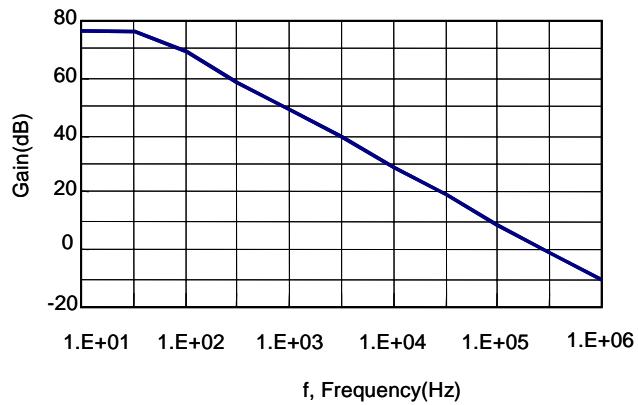


Figure 2. Open Loop Voltage Gain

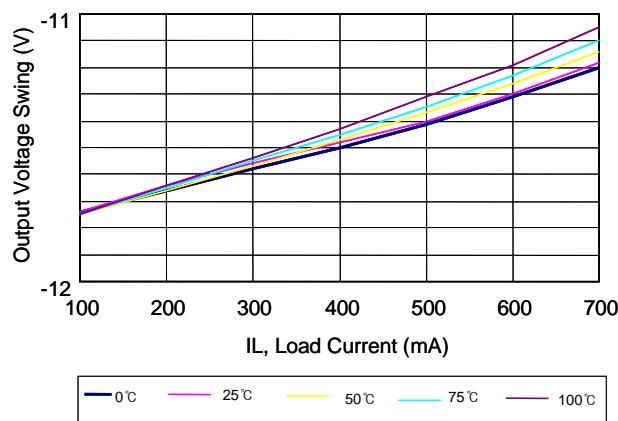


Figure 3-1. Output Voltage Swing vs Load Current

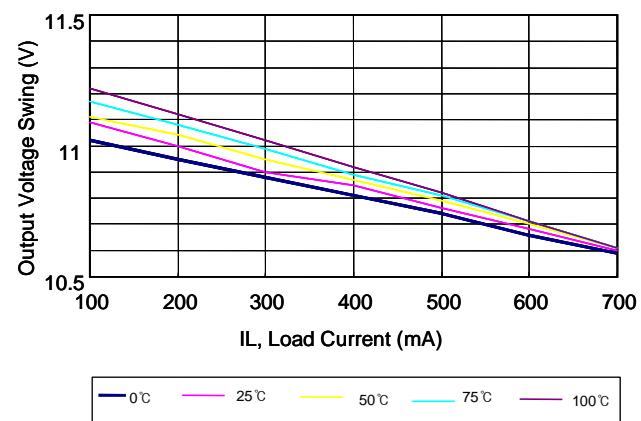


Figure 3-2. Output Voltage Swing vs Load Current

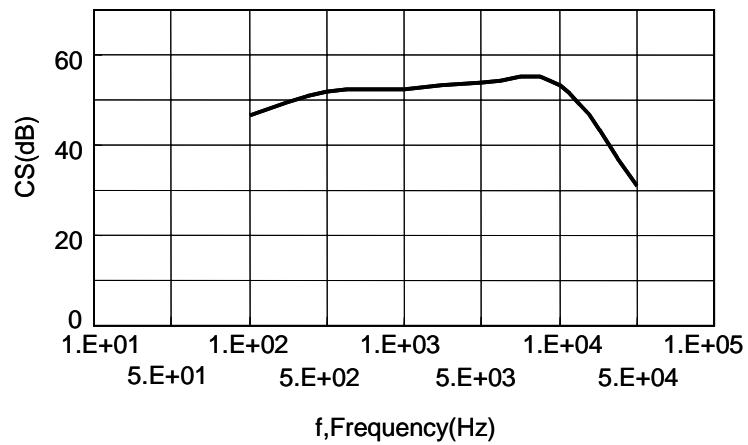
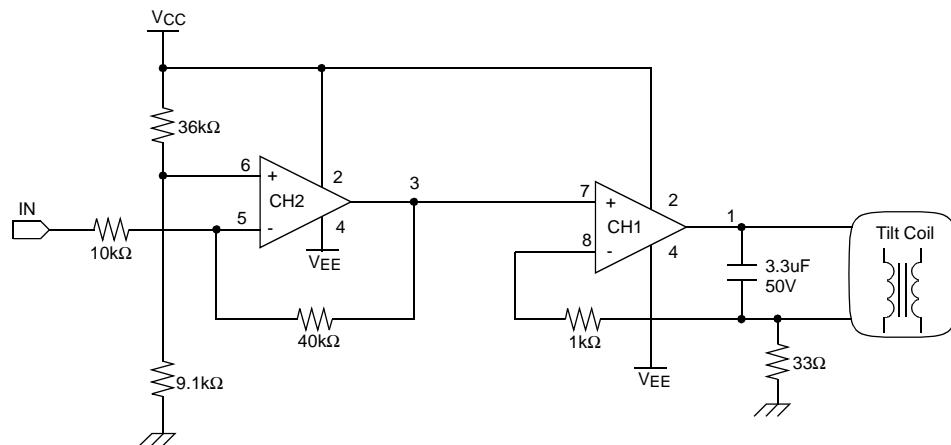


Figure 6. Channel Separation vs Frequency

Applications



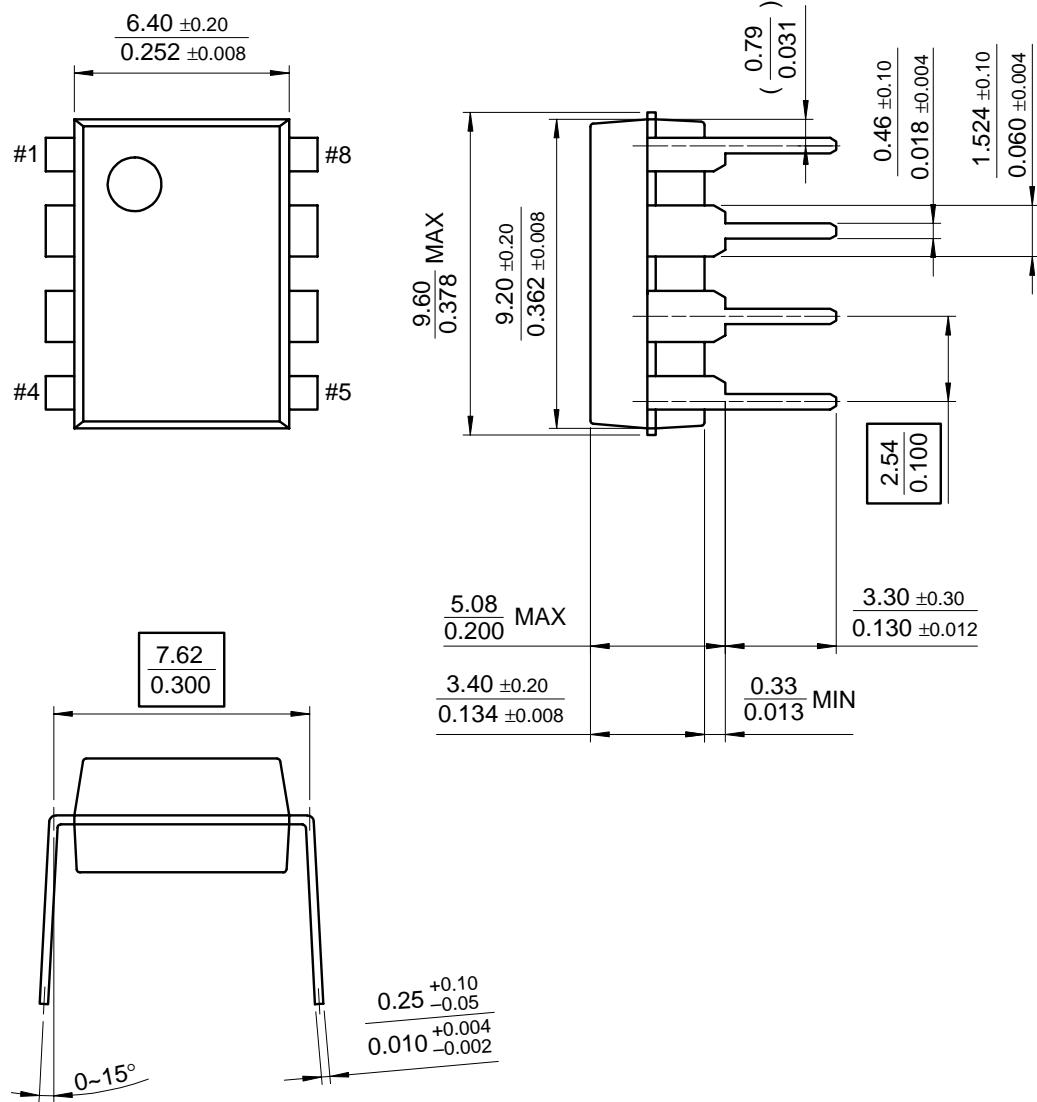
< Tilt Coil Current Control Circuit in Monitor, 8-DIP Package >

Mechanical Dimensions

Package

Dimensions in millimeters

8-DIP

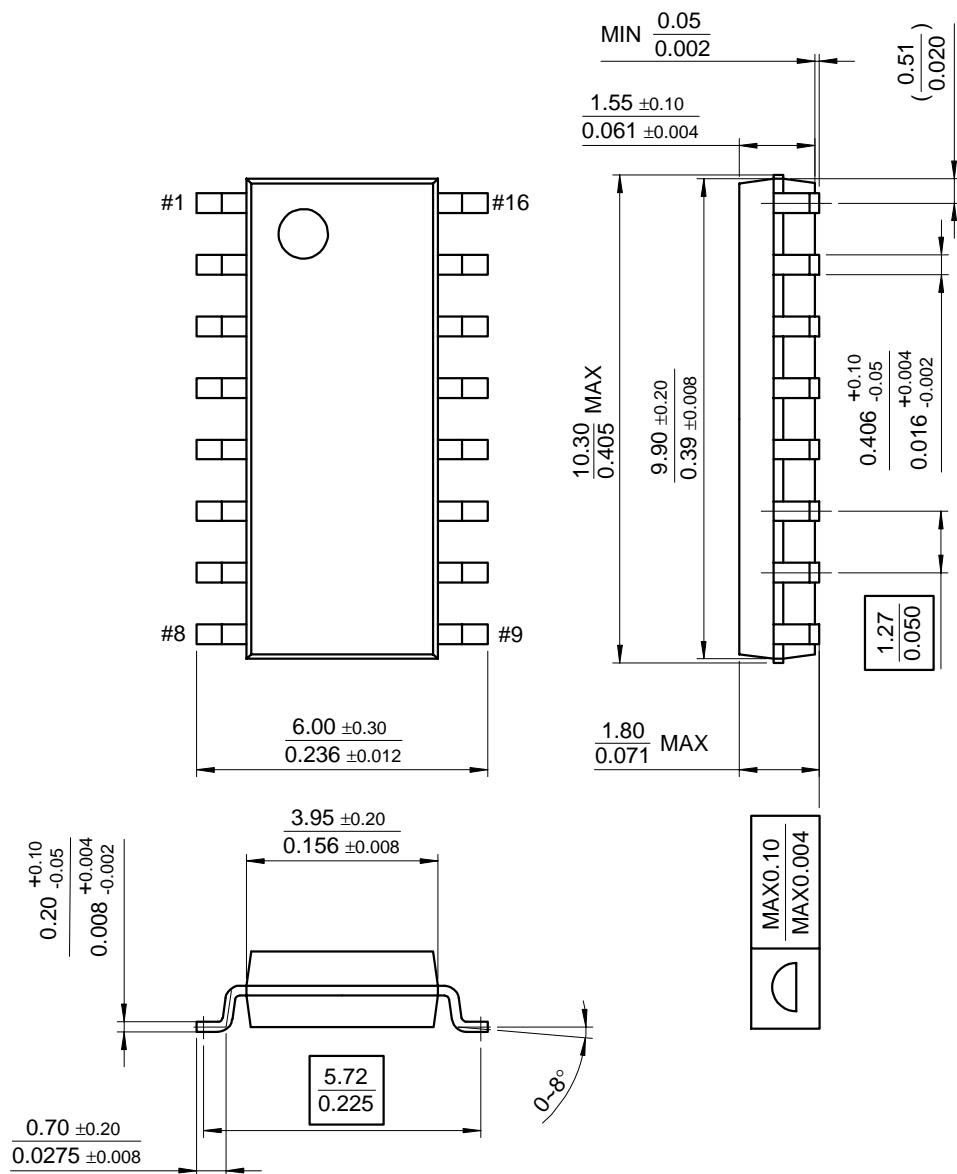


Mechanical Dimensions

Package

Dimensions in millimeters

16-SOP



Ordering Information

Product Number	Package	Operating Temperature
L272M	8-DIP	-25°C ~ +85°C
L272D2	16-SOP	

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